

# PE532DX

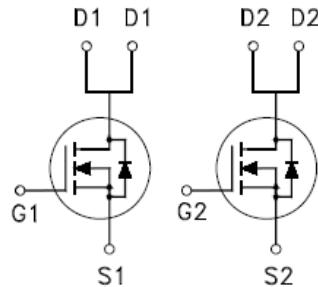
## Dual N-Channel Enhancement Mode MOSFET

### PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D^3$
30V	19mΩ @ $V_{GS} = 10V$	21A



PDFN 3x3P



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current <sup>3</sup>	$I_D$	21	A
		13	
		7.5	
		6	
Pulsed Drain Current <sup>1</sup>	$I_{DM}$	25	
Avalanche Current	$I_{AS}$	17	
Avalanche Energy	$E_{AS}$	15	
Power Dissipation	$P_D$	14	
		5	
		1.7	
		1.1	
Operating Junction & Storage Temperature Range	$T_j, T_{stg}$	-55 to 150	°C

### THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$	8.5	70	°C / W
Junction-to-Ambient <sup>2</sup>	$R_{\theta JA}$			

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ C$ .

<sup>3</sup>Package limitation current is 9A.

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#### ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	30			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1	1.5	2.5	
Gate-Body Leakage	$I_{\text{GSS}}$	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 24\text{V}, V_{\text{GS}} = 0\text{V}$			1	$\mu\text{A}$
		$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 55^\circ\text{C}$			10	
On-State Drain Current <sup>1</sup>	$I_{\text{D}(\text{ON})}$	$V_{\text{DS}} = 5\text{V}, V_{\text{GS}} = 10\text{V}$	25			A
Drain-Source On-State Resistance <sup>1</sup>	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 4.5\text{V}, I_D = 6.8\text{A}$		19.8	25	$\text{m}\Omega$
		$V_{\text{GS}} = 10\text{V}, I_D = 7.5\text{A}$		16.8	19	
Forward Transconductance <sup>1</sup>	$g_{\text{fs}}$	$V_{\text{DS}} = 10\text{V}, I_D = 7.5\text{A}$		22		S
<b>DYNAMIC</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 15\text{V}, f = 1\text{MHz}$		520		pF
Output Capacitance	$C_{\text{oss}}$			70		
Reverse Transfer Capacitance	$C_{\text{rss}}$			61		
Gate Resistance	$R_g$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$		2.2		$\Omega$
Total Gate Charge <sup>2</sup>	$Q_g(V_{\text{GS}} = 4.5\text{V})$	$V_{\text{DS}} = 15\text{V}, I_D = 7.5\text{A}$		7.8		nC
	$Q_g(V_{\text{GS}} = 10\text{V})$			14		
Gate-Source Charge <sup>2</sup>	$Q_{\text{gs}}$			2		
Gate-Drain Charge <sup>2</sup>	$Q_{\text{gd}}$			3.6		
Turn-On Delay Time <sup>2</sup>	$t_{\text{d}(\text{on})}$			14		
Rise Time <sup>2</sup>	$t_r$			10		
Turn-Off Delay Time <sup>2</sup>	$t_{\text{d}(\text{off})}$	$V_{\text{DD}} = 15\text{V}, I_D \geq 7.5\text{A}, V_{\text{GEN}} = 10\text{V}, R_G = 6\Omega$		30		nS
Fall Time <sup>2</sup>	$t_f$			10		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_J = 25^\circ\text{C}</math>)</b>						
Continuous Current <sup>3</sup>	$I_S$				21	A
Forward Voltage <sup>1</sup>	$V_{\text{SD}}$	$I_F = 7.5\text{A}, V_{\text{GS}} = 0\text{V}$			1	V
Reverse Recovery Time	$t_{\text{rr}}$	$I_F = 7.5\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$		12		nS
Reverse Recovery Charge	$Q_{\text{rr}}$			3		nC

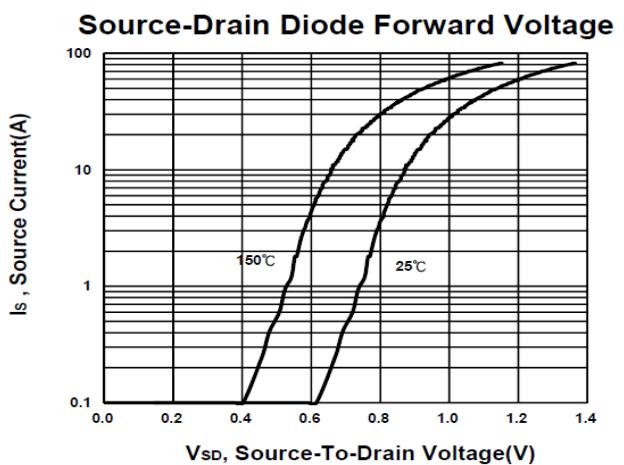
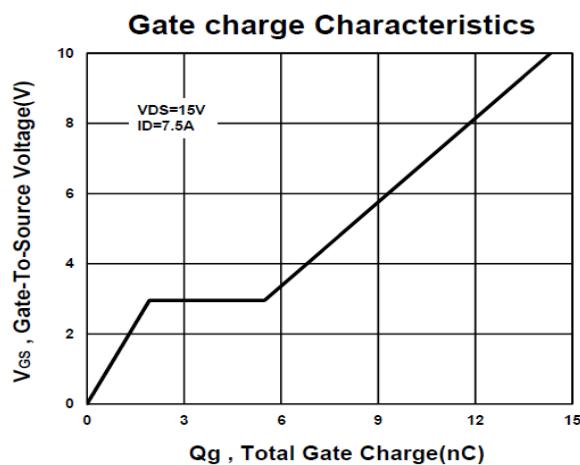
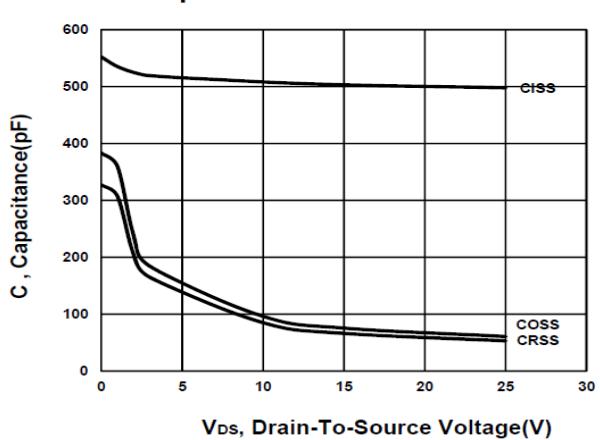
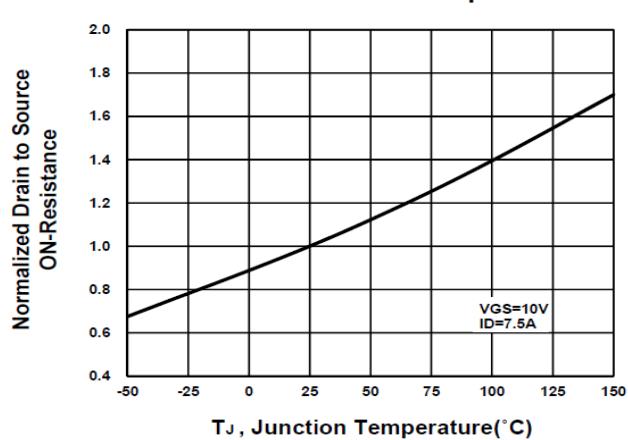
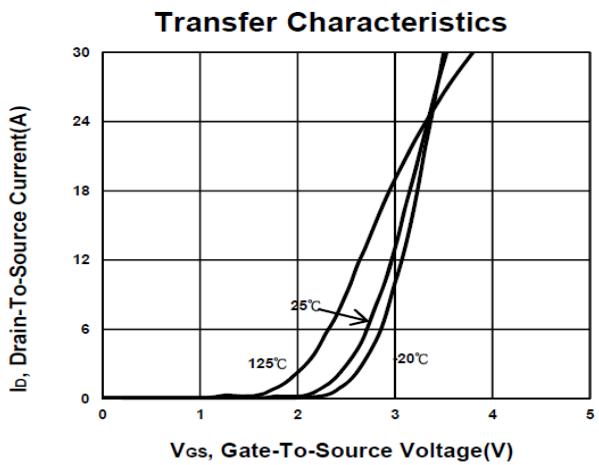
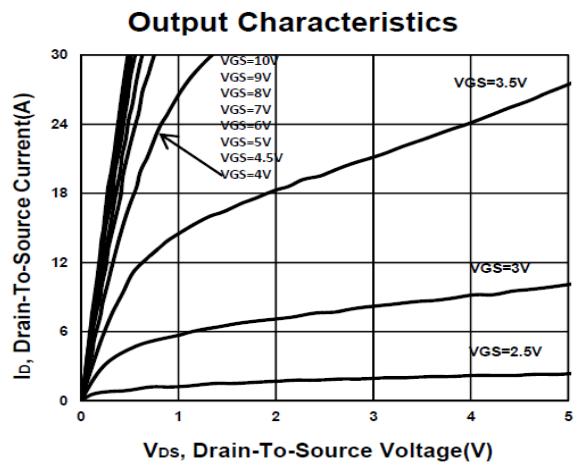
<sup>1</sup>Pulse test : Pulse Width  $\leq 300\ \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Package limitation current is 9A.

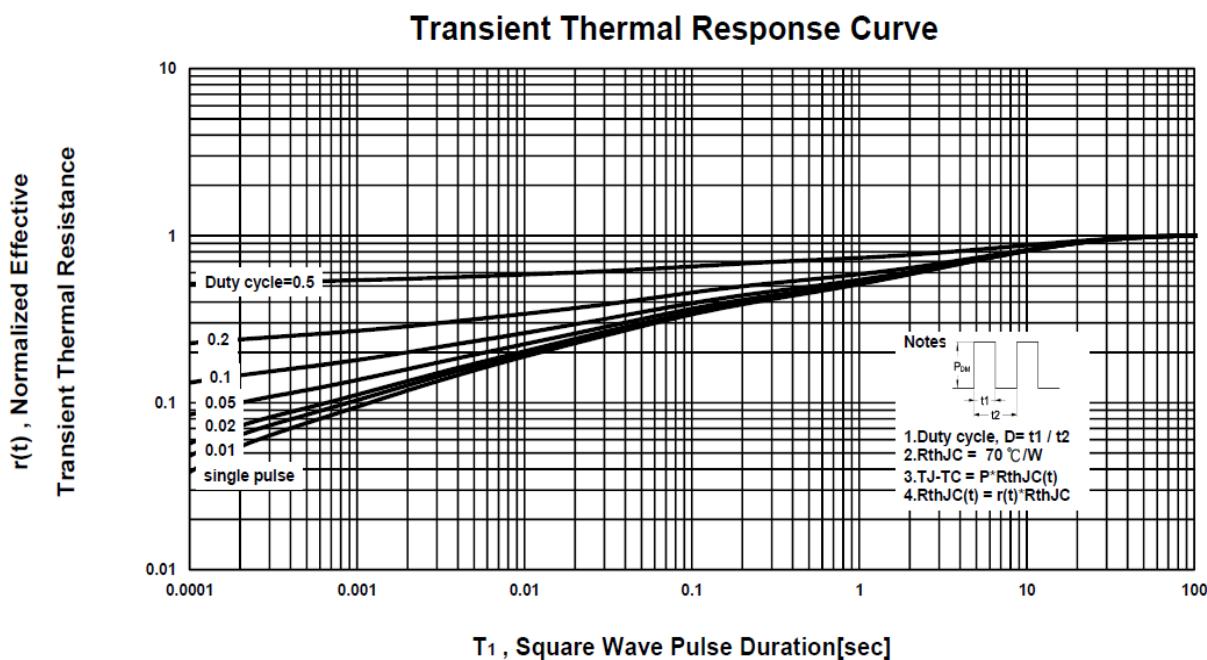
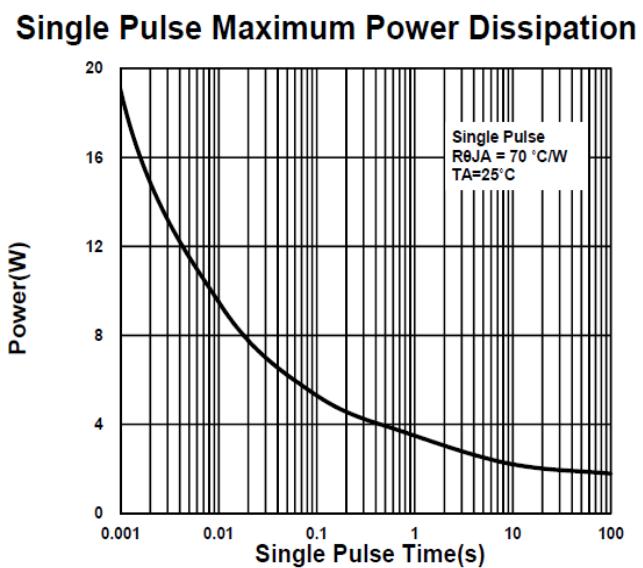
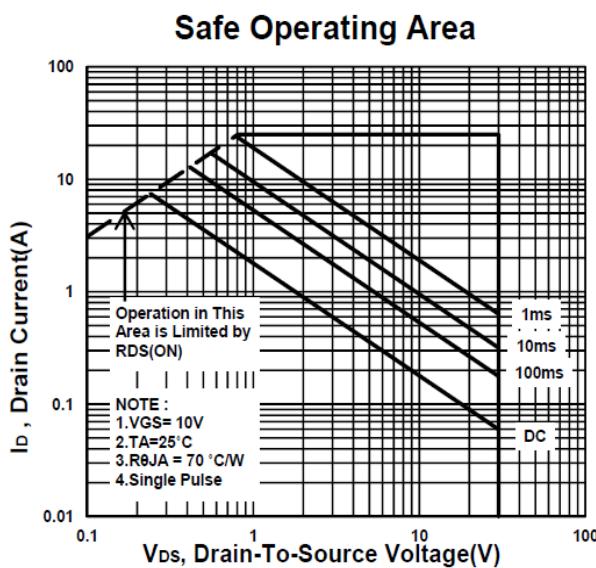
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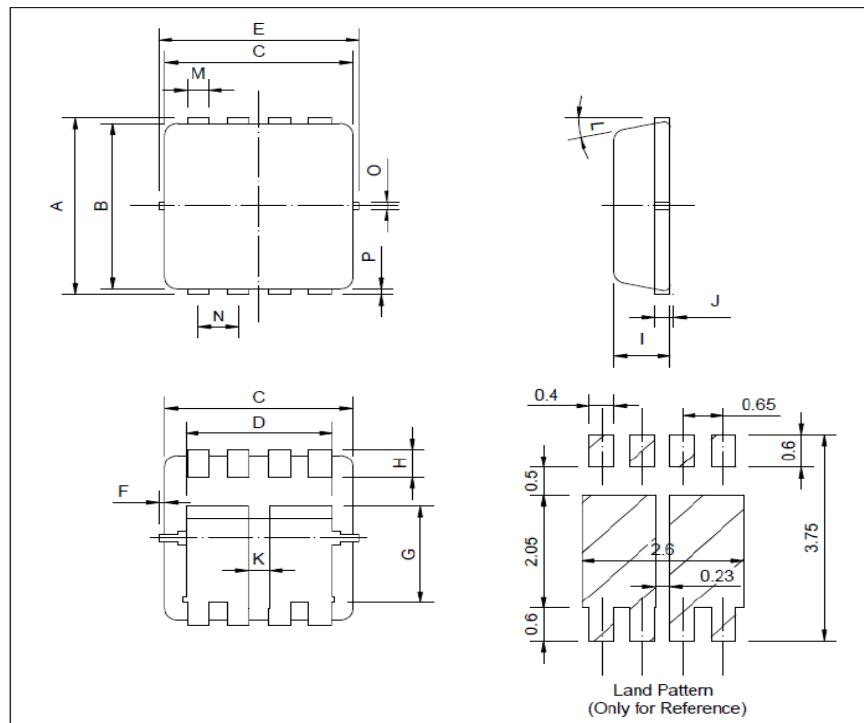
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### Dual N-Channel Enhancement Mode MOSFET

#### Package Dimension

#### PDFN 3x3P(Dual) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	3.2	3.3	3.4	I	0.7	0.75	0.8
B	2.95	3.05	3.15	J	0.1	0.15	0.25
C	2.95	3.05	3.15	K	0.35		
D		2.29		L	0°	10°	12°
E	3.2	3.3	3.4	M	0.27	0.32	0.37
F		0.13		N		0.65	
G	1.7	1.83	1.96	O		0.2	
H	0.3	0.4	0.5	P	0.06	0.13	0.2

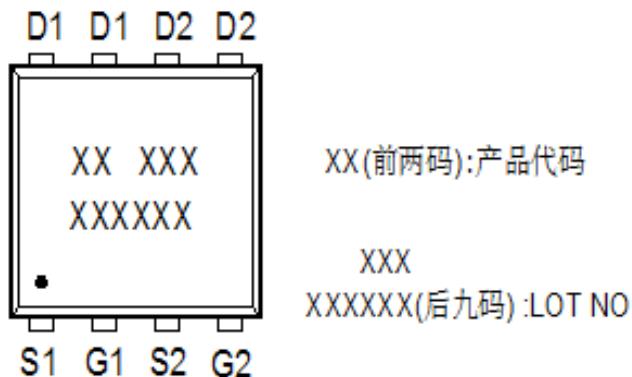


\*因为各家封装模具不同而外观略有差异，不影响电性及Layout。

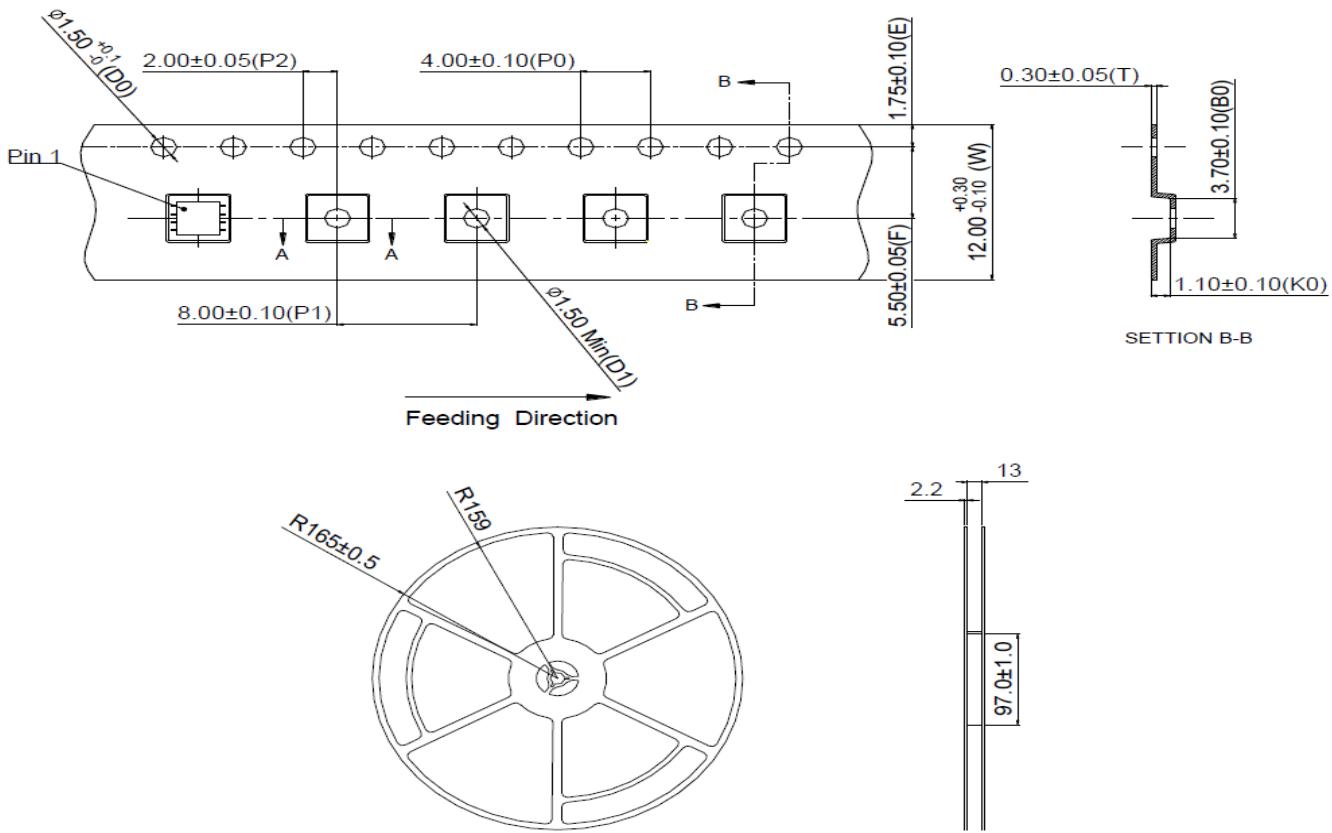
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### Dual N-Channel Enhancement Mode MOSFET

#### A. Marking Information(此产品代码为: E7)



#### B. Tape&Reel Information:5000pcs/Reel

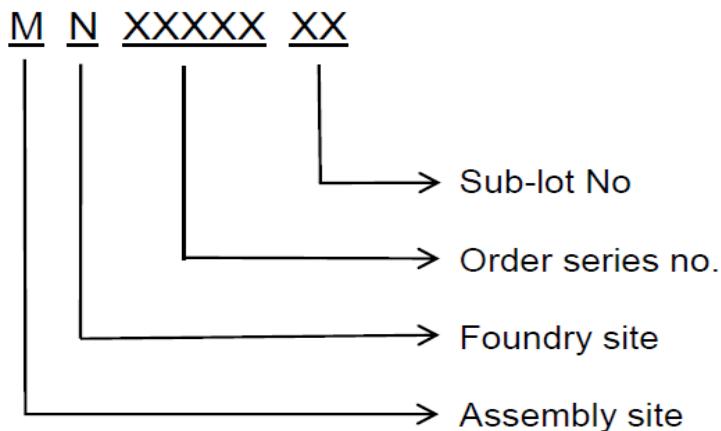


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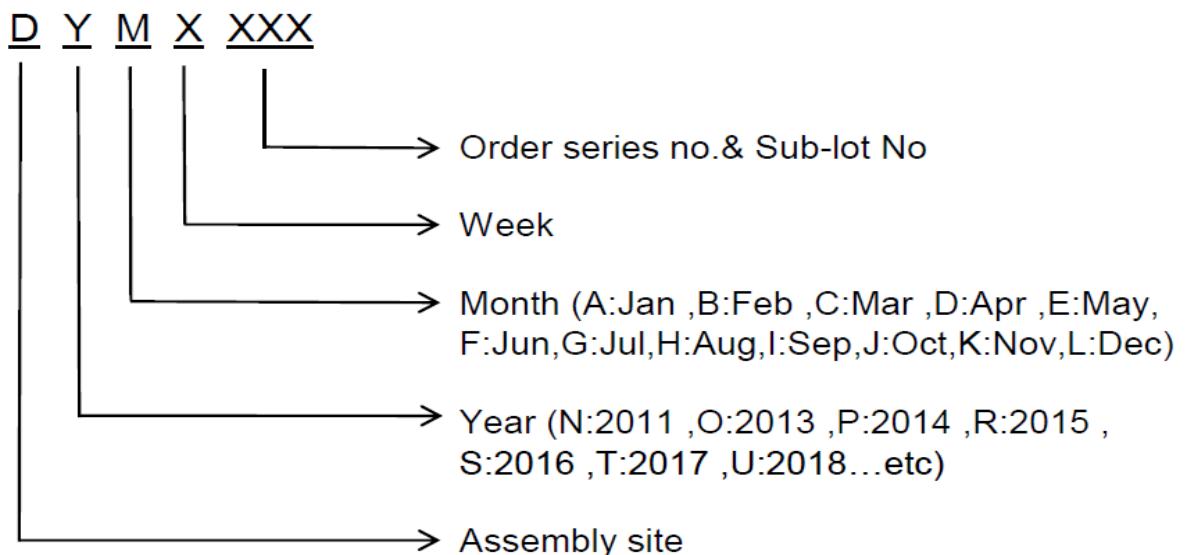
### Dual N-Channel Enhancement Mode MOSFET

#### C. Lot No.&Date Code rule

##### 1. Lot No.



##### 2. Date Code



# PE532DX

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### D.Label rule

标签内容(Label content)



1	Label Size	30 * 90 mm	
2	Font style	Times New Roman or Arial (或可区分英文“0”和数字“0”，“G”和“Q”的字型即可)	
3	U-NIKC	Height: 4 mm	
4	Package	Height: 2 mm	
5	Date	Height: 2 mm Shipping date: YYYY/MM/DD, ex. 2008/09/12	
6	Device	Height: 3 mm (Max: 16 Digit)	
7	Lot	Height: 3 mm (Max: 9 Digit) Sub lot	
8	D/C	Height: 3 mm (Max: 7 Digit)	
9	QTY	Height: 3 mm (Max: 6 Digit) Thousand mark is no needed	
10	RoHS label	 long axis: 12 mm      minor axis: 6 mm bottom color: White Font color: Black      Font style: Arial	
11	Halogen Free label	 Diameter: 10 mm      bottom color: Green Font color: Black      Font style: Arial	
12	Scan information	Device / Lot / D/C / QTY , Insert “ / ” between every parts. for example: P3055LDG/G12345601/GGG2301/2000 DPI (Dots per inch): Over 300 dpi Code : Code 128 Height: 6 mm at least	